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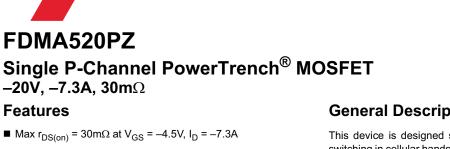


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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- Max $r_{DS(on)}$ = 53m Ω at V_{GS} = -2.5V, I_D = -5.5A
- Low profile 0.8mm maximum in the new package MicroFET 2X2 mm
- HBM ESD protection level > 3kV typical (Note 3)
- Free from halogenated compounds and antimony oxides
- RoHS Compliant

FAIRCHILD

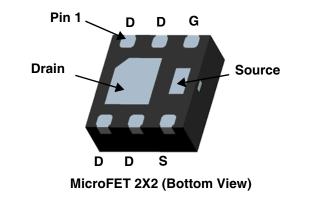


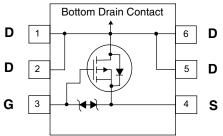
General Description

This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-state resistance.

June 2014

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		-20	V
V _{GS}	Gate to Source Voltage		±12	V
1	Drain Current -Continuous	(Note 1a)	-7.3	_
D	-Pulsed		-24	— A
D	Power Dissipation	(Note 1a)	2.4	W
P _D	Power Dissipation	(Note 1b)	0.9	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

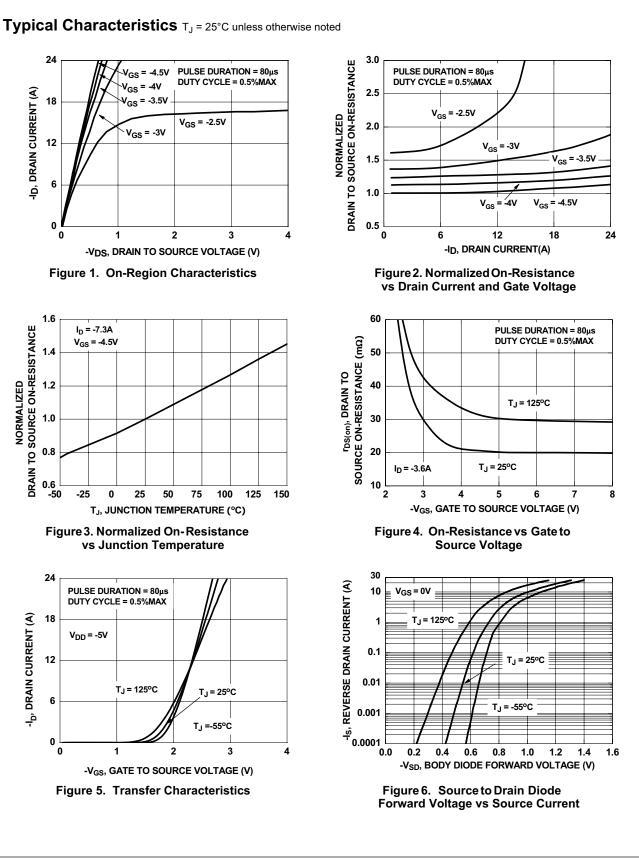
Thermal Characteristics

R _{0JA}	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	145	0/11

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
520	FDMA520PZ	MicroFET 2X2	7"	8mm	3000 units

Off Chara BV _{DSS} ΔBV _{DSS} ΔT _J I _{DSS}	cteristics Drain to Source Breakdown Voltage		Min	Тур	Max	Units
BV _{DSS} ΔBV _{DSS} ΔT _J						
ΔBV _{DSS} ΔT _J		I _D = –250μA, V _{GS} = 0V	-20			V
	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		-8.4		mV/°C
	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$			-1	μA
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 12V, V_{DS} = 0V$			±10	μA
On Chara	cteristics					
	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250μA	-0.6	-1.1	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C	-0.0	3.5	-1.5	mV/°C
Δīj		V _{GS} = -4.5V, I _D = -7.3A		26	30	-
DS(on)	Static Drain to Source On Resistance	$V_{GS} = -2.5V, I_D = -5.5A$		42	53	mΩ
D3(01)		$V_{GS} = -4.5V, I_D = -7.3A, T_J = 125^{\circ}C$		36	55	
9FS	Forward Transconductance	$V_{\rm DS} = -5V, I_{\rm D} = -7.3A$		22		S
	Characteristics			1		
	Input Capacitance			1235	1645	pF
C _{oss}	Output Capacitance	$-V_{DS} = -10V, V_{GS} = 0V,$		255	340	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		225	340	pF
Switching	Characteristics	V _{DD} = -10V, I _D = -7.3A				
t _{d(on)}	J Characteristics Turn-On Delay Time Rise Time			10 29	20 47	ns ns
td(on) tr td(off)	Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DD} = -10V, I_D = -7.3A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$		29 83	47 133	ns ns
td(on) tr td(off) tf	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time			29 83 74	47 133 119	ns ns ns
d(on) r d(off) f Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$		29 83 74 14	47 133	ns ns ns nC
td(on) tr td(off) tf Qg Qgs	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeGate to Source Gate Charge			29 83 74 14 2.9	47 133 119	ns ns nC nC
t _{d(on)} tr t <u>d(off)</u> tf Qg Qgs Qgd	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeGate to Source Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = -4.5V, R_{GEN} = 6Ω$ 		29 83 74 14	47 133 119	ns ns ns nC
ر ۲ ۲ ۲ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Irce Diode Characteristics	$V_{GS} = -4.5V, R_{GEN} = 6Ω$ $V_{DD} = -5V, I_D = -7.3A$ $V_{GS} = -4.5V$		29 83 74 14 2.9	47 133 119 20	ns ns nC nC nC
ر مر م م م م م م م م م م م م م م م م م	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Irce Diode Characteristics Maximum Continuous Drain-Source Diode	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DD} = -5V, I_D = -7.3A$ $V_{GS} = -4.5V$ de Forward Current		29 83 74 14 2.9 4.4	47 133 119 20 -2	ns ns nC nC nC
t _{d(on)} tr t <u>d(off)</u> tf Qg Qgs Qgd	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Irce Diode Characteristics	$V_{GS} = -4.5V, R_{GEN} = 6Ω$ $V_{DD} = -5V, I_D = -7.3A$ $V_{GS} = -4.5V$		29 83 74 14 2.9	47 133 119 20	ns ns nC nC nC

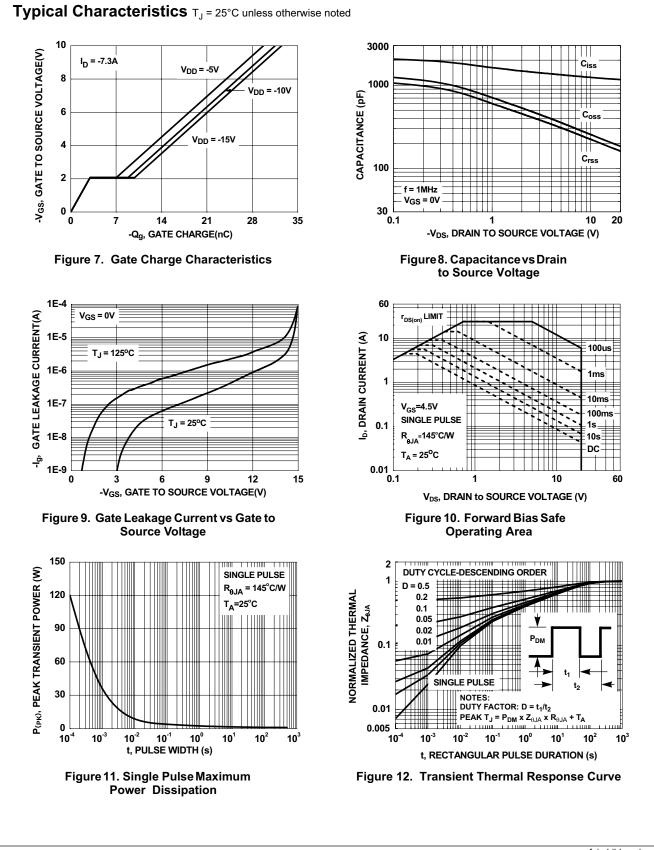


FDMA520PZ Rev.B3

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FDMA520PZ Single P-Channel PowerTrench[®] MOSFET

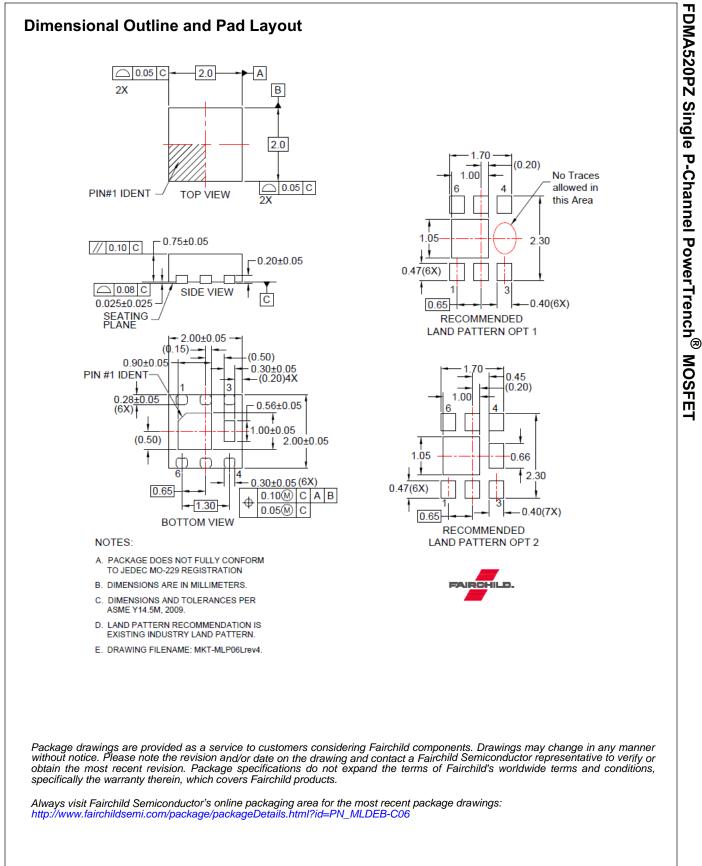


FDMA520PZ Rev.B3

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FDMA520PZ Single P-Channel PowerTrench[®] MOSFET



MOSFET



Obsolete

Not In Production

Datasheet contains specifications on a product that is discontinued by Fairchild

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